

SMD Schottky Barrier Diode

COMCHIP
SMD Diodes Specialist

CDBF0230R (Lead-free Device)

I_o = 200 mA

V_R = 30 Volts

Features

Low forward Voltage

Designed for mounting on small surface.

Extremely thin/leadless package.

Majority carrier conduction.



Mechanical data

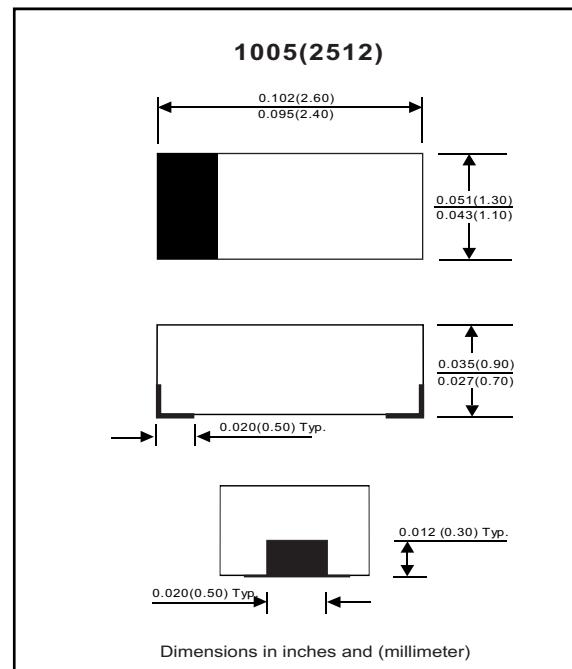
Case: SOD-323F (2512) Standard package , molded plastic.

Terminals: Gold plated, solderable per MIL-STD-750, method 2026.

Polarity: Indicated by cathode band.

Mounting position: Any.

Weight: 0.006 gram (approximately).



Maximum Rating (at T_A = 25°C unless otherwise noted)

Parameter	Conditions	Symbol	Min	Typ	Max	Unit
Repetitive peak reverse voltage		V _{RRM}			35	V
Reverse voltage		V _R			30	V
Average forward rectified current		I _o			200	mA
Forward current , surge peak	8.3 ms single half sine-wave superimposed on rate load (JEDEC method)	I _{FSM}			1	A
Storage temperature		T _{STG}	-40		+125	°C
Junction temperature		T _j	-40		+125	°C

Electrical Characteristics (at T_A = 25°C unless otherwise noted)

Parameter	Conditions	Symbol	Min	Typ	Max	Unit
Forward voltage	I _F = 200 mA	V _F			0.6	V
Reverse current	V _R = 10 V	I _R			1	uA

RATING AND CHARACTERISTIC CURVES (CDBF0230R)

Fig. 1 - Forward characteristics

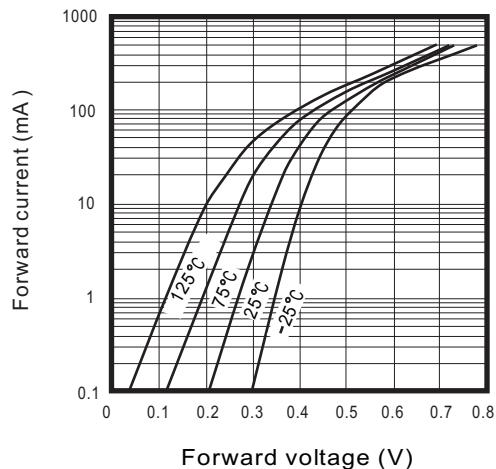


Fig. 2 - Reverse characteristics

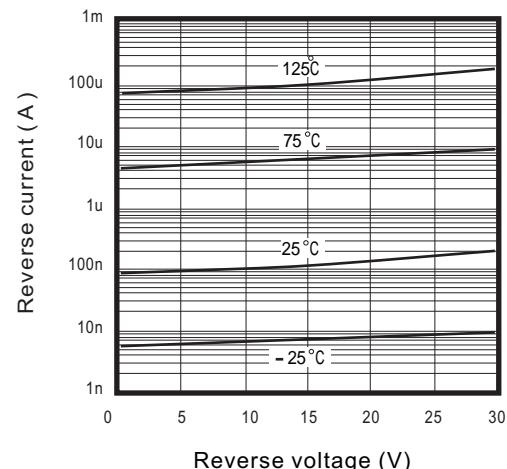


Fig. 3 - Capacitance between terminals characteristics

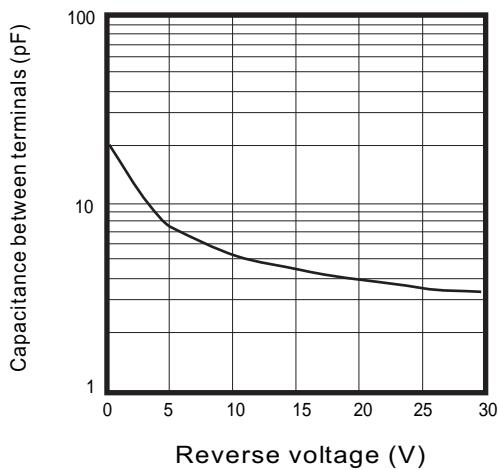


Fig. 4 - Current derating curve

